



IQS7222B OVERVIEW

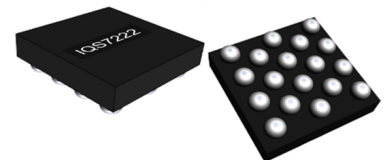
18 Channel Mutual / 8 Channel Self- Capacitive Touch and Proximity Controller with I²C communications interface, configurable GPIOs and low power options

1 Device Overview

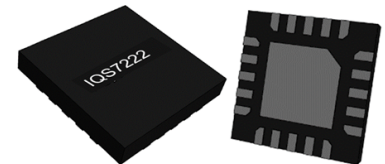
The IQS7222B ProxFusion® IC is a sensor fusion device for various multi-button applications. The sensor is fully I²C compatible and on-chip calculations enable the IC to respond effectively even in lowest power modes.

1.1 Main Features

- > Highly flexible ProxFusion® device
- > 9 (QFN) / 8 (WLCSP) external sensor pad connections
- > Configure up to 18 Mutual capacitance buttons or up to 8 self-capacitance buttons
- > Built-in basic functions:
 - Automatic tuning
 - Noise filtering
 - Debounce & hysteresis
 - Dual direction trigger indication
- > Design simplicity
 - PC Software for debugging and obtaining optimal settings and performance
 - One-time programmable settings for custom power-on IC configuration
 - Auto-run from programmed settings for simplified integration
- > Automated system power modes for optimal response vs consumption
- > I²C communication interface with IRQ/RDY (up to fast plus -1MHz)
- > Event and streaming modes
- > Customizable user interface due to programmable memory
- > Customizable user interface due to programmable memory
- > Supply Voltage 1.8V(-5%) to 3.5V
- > Small packages
 - WLCSP18 (1.62 x 1.62 x 0.5 mm) - interleaved 0.4mm x 0.6mm ball pitch
 - QFN20 (3 x 3 x 0.5 mm) - 0.4mm pitch



WLCSP18 & QFN20 package
Representation only



1.2 Applications

- > Remote Control User Interface
- > Home Automation Device User Interface
- > Wireless Speaker Controls



1.3 Block Diagram

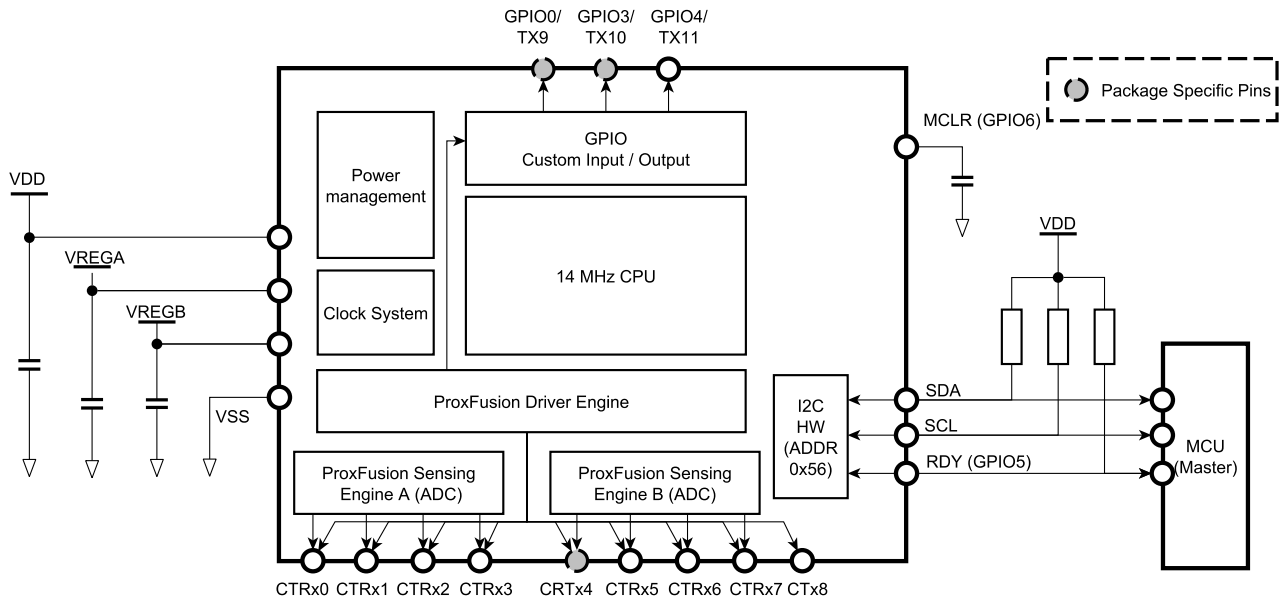


Figure 1.1: Functional Block Diagram

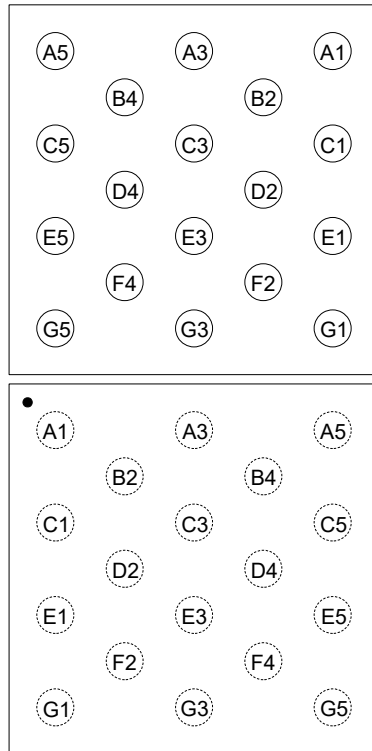
ⁱWLCSP18 packages do not have a CRX4 and combines GPIO and GPIO3



2 Hardware Connection

2.1 WLCSP18 Pin Diagrams

Table 2.1: 18-pin WLCSP18 Package (Bottom/Ball-side View)



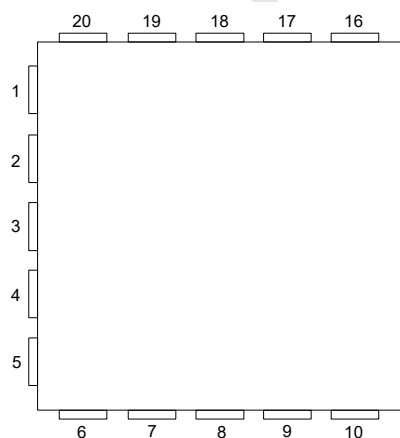
Ball-side View

Top side View

Pin no.	Signal
A5	GPIO6 / MCLR
A3	SCL/ GPIO2
A1	Tx9/Tx10/GPIO0/GPIO3 ⁱ
B4	SDA/GPIO1
B2	Tx11/GPIO4
C5	Vdd
C3	RDY/ GPIO5
C1	Tx8
D4	Vss
D2	CRx2/Tx2
E5	VregD
E3	CRx1/Tx1
E1	CRx6/Tx6
F4	CRx0/Tx0
F2	CRx5/Tx5
G5	VregA
G3	CRx3/Tx3
G1	CRx7/Tx7

2.2 QFN20 Pin Diagram

Table 2.2: 20-pin QFN Package (Top View)



Pin no.	Signal name	Pin no.	Signal name
1	VDD	11	CRx6
2	VREGD	12	CRx7
3	VSSD & VSSA	13	CTx8
4	VREGA	14	GPIO0
5	CRx0	15	GPIO3
6	CRx1	16	GPIO4
7	CRx2	17	GPIO5
8	CRx3	18	GPIO2
9	CRx4	19	GPIO1
10	CRx5	20	GPIO6

Area name	Signal name
Tab	Float

ⁱPlease note that CTx9 and CTx10 are shorted in the WLCSP18 package

2.3 Reference Schematic

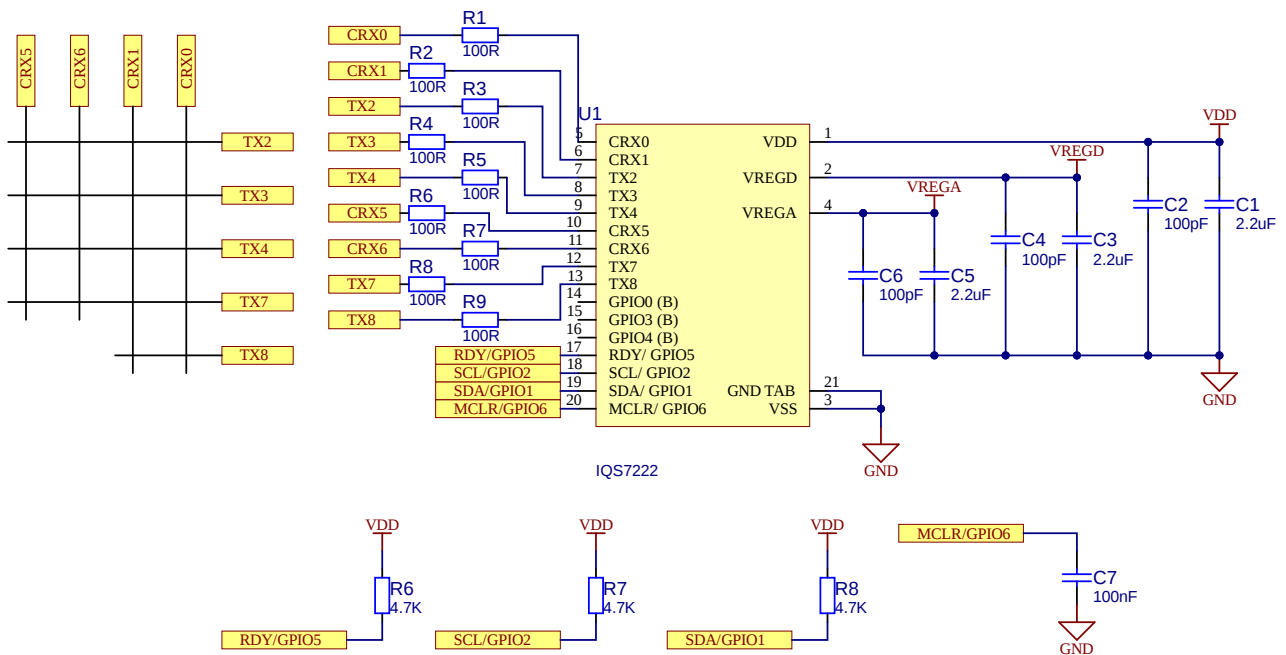


Figure 2.1: 18 Button Mutual Capacitance Reference Schematic

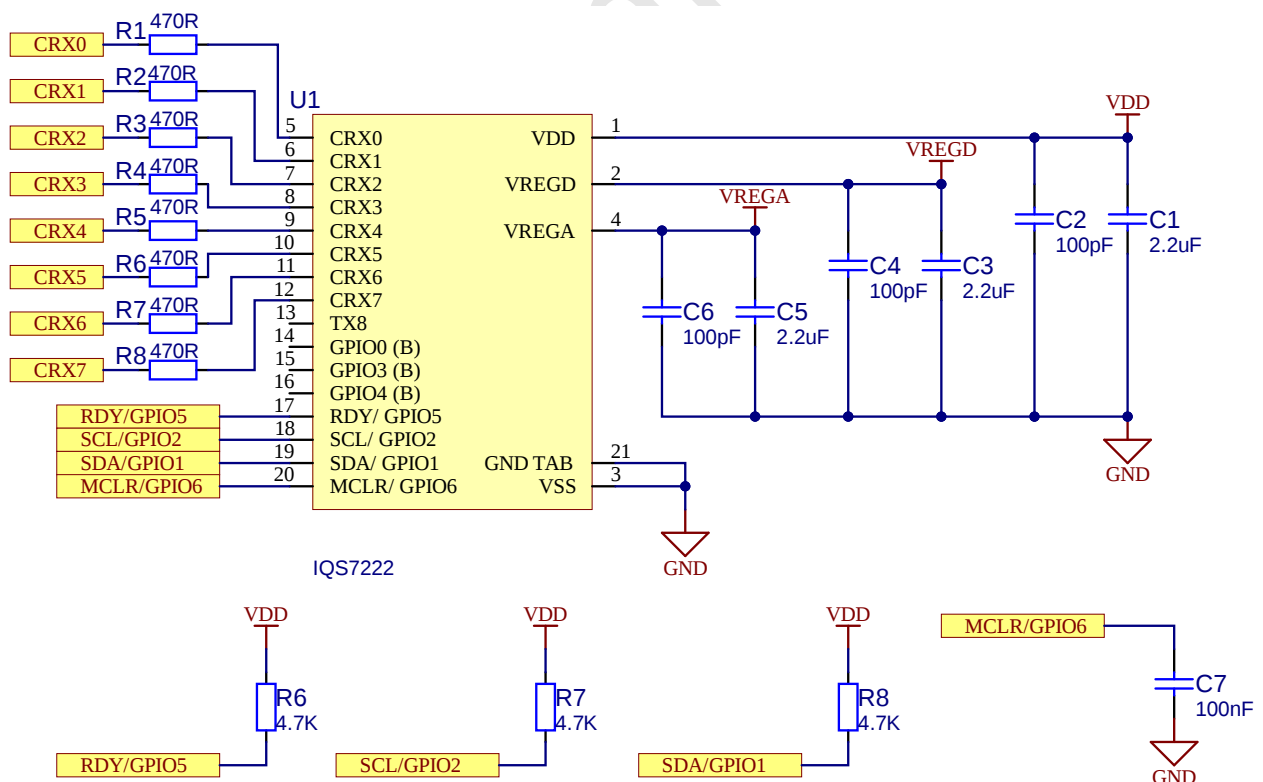


Figure 2.2: 8 Button Self Capacitance Reference Schematic



3 Electrical Characteristics

3.1 Absolute Maximum Ratings

	Min	Max	Unit
Voltage applied at VDD pin to VSS	1.71	3.5	V
Voltage applied to any ProxFusion® pin	-0.3	VREG	V
Voltage applied to any other pin (referenced to VSS)	-0.3	VDD + 0.3 (3.5V max)	V
Storage temperature, T _{stg}	-40	85	°C

3.2 ESD Rating

	Value	Unit
V _(ESD) Electrostatic discharge Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁱ	± 4000	V

3.3 Recommended Operating Conditions

Recommended operating conditions		Min	Nom	Max	Unit
VDD	Supply voltage applied at VDD pin	1.71		3.5	V
VregA	Analog-domain Regulator output at VregA	1.5	1.53	1.75	V
VregD	Digital-domain Regulator output at VregD	1.57	1.59	1.8 ⁱⁱ	V
VSS	Supply voltage applied at VSS pin	0	0	0	V
T _A	Operating free-air temperature	-40	25	85	°C
C _{VDD}	Recommended capacitor at VDD	1	2	10	μF
C _{VREGA}	Recommended external buffer capacitor at VREG, ESR ≤ 200mΩ	1	2	10	μF
C _{VREGD}	Recommended external buffer capacitor at VREG, ESR ≤ 200mΩ	1	2	10	μF
C _{X_SELF-VSS}	Maximum capacitance of all external electrodes on all ProxFusion® blocks (self-capacitance mode)	-	-	400	pF
C _{m_CTX-CRX}	Capacitance of all external electrodes on all ProxFusion® blocks (mutual-cap mode)	0.1	-	90	pF
C _{X_CRX-VSS-1M}	Maximum capacitance of all external electrodes on all ProxFusion® blocks (mutual-capacitance mode @ f _{xfer} =1MHz)			100	pF
C _{X_CRX-VSS-4M}	Maximum capacitance of all external electrodes on all ProxFusion® blocks (mutual-capacitance mode @ f _{xfer} =4MHz sensing))			25	pF
$\frac{C_{X_{CRX-VSS}}}{C_{m_{CTX-CRX}}}$	Capacitance ratio for optimal SNR in mutual capacitance mode	10		20	n/a
RC _{X_CRX/CTX}	Series (in-line) resistance of all mutual capacitance pins (Tx & Rx pins) in mutual capacitance mode	0 ⁱⁱⁱ	0.47	10 ^{iv}	kΩ
RC _{X_SELF}	Series (in-line) resistance of all self capacitance pins in self capacitance mode	0 ⁱⁱ	0.47	10 ^{iv}	kΩ

ⁱ JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process. Pins listed as ±4000 V may actually have higher performance.

ⁱⁱ V_{dd} ≥ 2V

ⁱⁱⁱ Nominal series resistance of 470Ω is recommended to prevent received and emitted EMI effects. Typical resistance also adds additional ESD protection

^{iv} Series resistance limit is a function of f_{xfer} and the circuit time constant, RC. R_{max} × C_{max} = $\frac{1}{(6 \times f_{xfer})}$ where "C" is the pin capacitance to Vss.



4 Ordering Information

IQS7222B zzz ppb

IC NAME	IQS7222B	=	IQS7222B	
POWER-ON CONFIGURATION	zzz	=	000	I ² C with initialize settings requirement
		=	CS	WLCSP-18 package
PACKAGE TYPE	pp	=	QN	QFN-20 package
				WLCSP-18 Reel (3000pcs/reel)
BULK PACKAGING	b	=	R	QFN-20 Reel (2000pcs/reel)

Figure 4.1: Order Code Description

Preliminary

5 Package Specification

5.1 Package Outline Description - WLCSP18

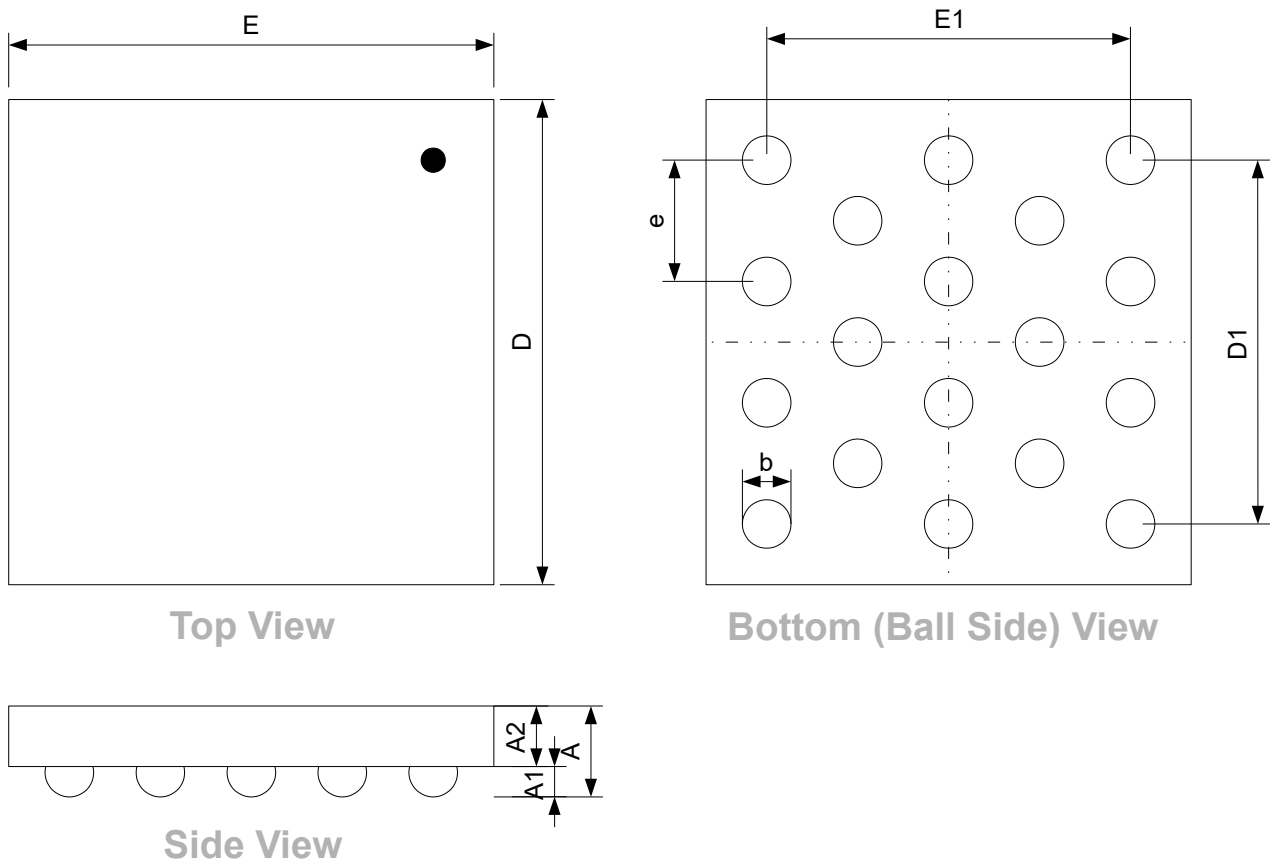


Figure 5.1: WLCSP (1.62x1.62) - 18 Package Outline Visual Description

Table 5.1: WLCSP (1.62x1.62) - 18 Package Outline Visual Description

Dimension	[mm]	Dimension	[mm]
A	0.525±0.05	D1	1.2
A1	0.2±0.02	E	1.620±0.015
A2	0.3±0.025	E1	1.2
b	0.260±0.39	e	0.4
D	1.620±0.015		

5.2 Package Outline Description - QFN20

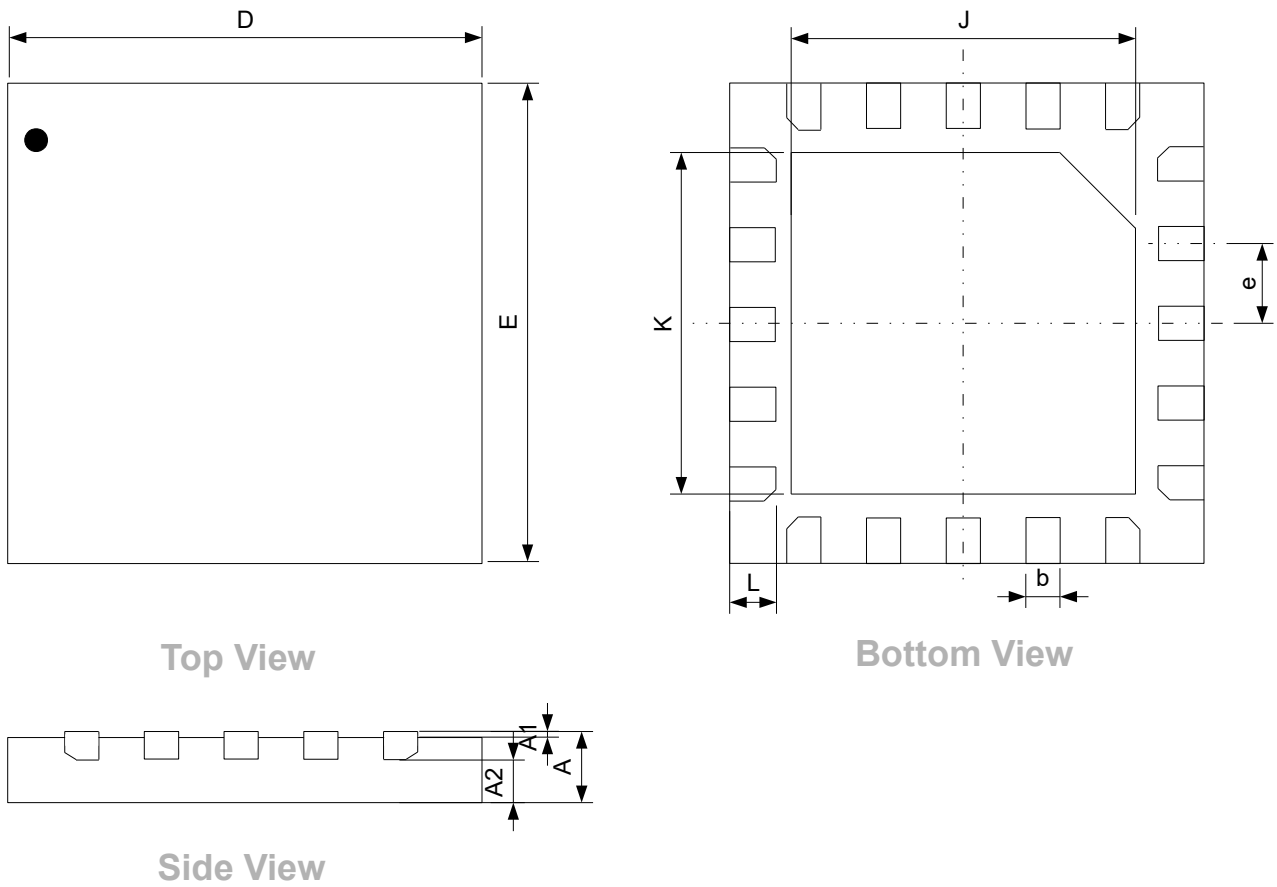


Figure 5.2: QFN (3x3)-20 Package Outline Visual Description

Table 5.2: QFN (3x3)-20 Package Outline Visual Description

Dimension	[mm]	Dimension	[mm]
A	0.5 ± 0.1	E	3
A1	0.035 ± 0.05	e	0.4
A2	0.3	J	1.7 ± 0.1
A3	0.203	K	1.7 ± 0.1
b	0.2 ± 0.05	L	0.4 ± 0.05
D	3		



Contact Information

	USA	Asia	South Africa
Physical Address	11940 Jollyville Rd Suite 120-S Austin TX-78759 USA	Room501A, Block A T-Share International Centre Taoyuan Road Nanshan District Shenzen Guangdong Province PRC	1 Bergsig Avenue Paarl 7646 South Africa South Africa
Postal Address	11940 Jollyville Rd Suite 120-S Austin TX-78759 USA	Room501A, Block A T-Share International Centre Taoyuan Road Nanshan District Shenzen Guangdong Province PRC	PO Box 3534 Paarl 7620 South Africa South Africa
Tel	+1 512 538 1995	+86 755 8303 5294 ext 808	+27 21 863 0033
Email	info@azoteq.com	info@azoteq.com	info@azoteq.com

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